### PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3401156

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
CHUN-HSIUNG HUNG	06/05/2015
KUEN-LONG CHANG	06/05/2015
KEN-HUI CHEN	06/05/2015
SU-CHUEH LO	06/05/2015
TZU-TING CHIU	06/04/2015

#### **RECEIVING PARTY DATA**

Name:	MACRONIX INTERNATIONAL CO., LTD.	
Street Address:	NO. 16, LI-HSIN ROAD	
Internal Address:	ss: SCIENCE-BASED INDUSTRIAL PARK	
City:	HSINCHU	
State/Country:	TAIWAN	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14742160

#### **CORRESPONDENCE DATA**

**Fax Number:** (202)408-4400

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 202.216.5492

Email:gonnella@finnegan.comCorrespondent Name:MACRONIX/FINNEGANAddress Line 1:901 NEW YORK AVE., NWAddress Line 4:WASHINGTON, D.C. 20001

ATTORNEY DOCKET NUMBER:	08409.0098-00000	
NAME OF SUBMITTER:	AMY-MARIE GONNELLA	
SIGNATURE:	/Amy-Marie Gonnella/	
DATE SIGNED:	06/17/2015	
	This document serves as an Oath/Declaration (37 CFR 1.63).	

**Total Attachments: 5** 

PATENT REEL: 035941 FRAME: 0990

503354535



PATENT REEL: 035941 FRAME: 0991

## ASSIGNMENT AND DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION

WHEREAS I/We, the below named inventor(s), (hereinafter referred to as Assignor(s)), of a claimed invention in an application for United States Letters Patent entitled:

# CIRCUIT WITH OUTPUT SWITCH WHEREAS, Macronix International Co., Ltd. a corporation of Republic of China (R.O.C.)

whose post office address is No. 16, Li-Hsin Road, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

(hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I/We, as Assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention, provisional Application No. , filed , and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority in any foreign country on the basis of the above provisional application (if any), as well as all rights to claim priority on the basis of this application in any foreign country, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and I/We hereby authorize and request the Director of the United States Patent and Trademark Office and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

attached herewith.

AND, I/WE HEREBY authorize and request to parentheses (Application No of said application when known.	hat the attorneys having Power of , filed	Attorney in this application, insert here in) the filing date and application number
As a named inventor below, I hereby declare (2) the above-identified application was made as stated below next to my name; and (4) I be invention in the application. I hereby askers	that: (1) This declaration is direct	ed to the above-identified application;
invention in the application. I hereby acknow punishable by fine or imprisonment of not mostates Code.	IRCCOR TOST SOLVIANITUI TOLOG STATAGE	
As a below named inventor, I have reviewed a aware of the duty to disclose to the US PTO a 37C.F.R. § 1.56.	and understand the contents of the all information known to me to be r	e application, including the claims, and an naterial to patentability as defined in
Authorization To Permit Access To Application by P	articipating Offices:	
☐ If checked, the undersigned hereby grants the (JPO), the Korean Intellectual Property Office (KIPO), the which a foreign application claiming priority to the above property office in which a foreign application claiming pripatent application. See 37 CFR 1.14(c) and (h). This bo intellectual property office in which a foreign application identified patent application.	in the lectual Property Office (WIP) -identified patent application is filed accessority to the above-identified patent applications about a policient of the checked if the Applicant of the Checked if the Che	ss to the above-'KIPO, WIPO, or other intellectual ation is filed to have access to the above-identified
In accordance with 37 CFR 1.14(h)(3), access will be pro- identified patent application-as-filed; 2) any foreign applic (d) if a copy of the foreign application that satisfies the ca application; and 3) any U.S. application-as-filed from whi	cation to which the above-identified paters	t application claims priority under 35 U.S.C. 119(a
In accordance with 37 CFR 1.14(c), access may be provided Application by Participating Offices.	ided to information concerning the date of	filing the Authorization to Permit Access to
IN TESTIMONY WHEREOF, I/We have hereur	nto set our hands.	
FULL NAME OF SOLE OR FIRST ASSIGNOR	ASSIGNOR'S SIGNATURE	A DATE
Chun-Hsiung HUNG	Chun History Hu	ng 2015/6/5
MAILING ADDRESS 9F2, No. 86, Dasyue Rd.,_Hsinchu City 300, Taiw		RESIDENCE Hsinchu City,
2. FULL NAME OF SECOND ASSIGNOR, IF ANY	ASSIGNOR'S SIGNATURE	Taiwan (R.O.C.) DATE
Kuen-Long CHANG	Kuen-Long Cham	2015/6/5
MAILING ADDRESS No. 255, Qiyan Rd., Beitou Dist., Taipei City 112, T	alwan (R.O.C.)	RESIDENCE Taipei City,
3. FULL NAME OF THIRD ASSIGNOR, IF ANY	ASSIGNORIS SIGNATURE	Taiwan (R.O.C.)

ASSIGNOR'S SIGNATURE

9F., No. 8, Aly. 10, Ln. 171, Sec. 1, ZhongCheng Rd., Shilin Dist., Taipei City 111, Taiwan(R.O.C.)

Page 2 of 3

Ken-Hui CHEN

MAILING ADDRESS

3. FULL NAME OF THIRD ASSIGNOR, IF ANY

DATE

2015

RESIDENCE

Taipei City, Taiwan (R.O.C.)

4. FULL NAME OF FOURTH ASSIGNOR, IF ANY	ASSIGNOR'S SIGNATURE	DATE
Su-Chueh LO	Su-Chieh 20	2015.6.5.
MAILING ADDRESS 2F., No. 99, Xinzhuang St., Hsinchu City 300, Taiwan (R.O.C.)		RESIDENCE Hsinchu City, Taiwan (R.O.C.)
5. FULL NAME OF FIFTH ASSIGNOR, IF ANY Tzu-Ting CHIU	ASSIGNOR'S SIGNATURE	DATE
MAILING ADDRESS 2F., No. 80, Wenlin Rd., Shilin Dist., Taipei City 111, Taiwan (R.O.C.)		RESIDENCE Taipei City, Taiwan (R.O.C.)

#### ASSIGNMENT AND DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION

WHEREAS I/We, the below named inventor(s), (hereinafter referred to as Assignor(s)), of a claimed invention in an application for United States Letters Patent entitled:

#### CIRCUIT WITH OUTPUT SWITCH

attached herewith.
WHEREAS, Macronix International Co., Ltd. a corporation of Republic of China (R.O.C.)
whose post office address is No. 16, Li-Hsin Road, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.
(hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;
NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I/We, as Assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention, provisional Application No, filed, and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority in any foreign country on the basis of the above provisional application (if any), as well as all rights to claim priority on the basis of this application in any foreign country, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and I/We hereby authorize and request the Director of the United States Patent and Trademark Office and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

4. FULL NAME OF FOURTH ASSIGNOR, IF ANY	ASSIGNOR'S SIGNATURE	DATE
Su-Chueh LO		
MAILING ADDRESS 2F., No. 99, Xinzhuang St., Hsinchu City 300, Taiwan (R.O.C.)		RESIDENCE Hsinchu City, Taiwan (R.O.C.)
5. FULL NAME OF FIFTH ASSIGNOR, IF ANY	ASSIGNOR'S SIGNATURE	DATE
Tzu-Ting CHIU	Tzu-Ting CHTU	20/5/6/4
MAILING ADDRESS  2F., No. 80, Wenlin Rd., Shilin Dist., Taipei City 111, Taiwan (R.O.C.)		RESIDENĆE Taipei City, Taiwan (R.O.C.)

**RECORDED: 06/17/2015**